74LVC594A

8-bit shift register with output register

Rev. 2 — 21 October 2013

Product data sheet

1. General description

The 74LVC594A is an 8-bit serial-in/serial or parallel-out shift register with a storage register. Separate clock and reset inputs are provided on both shift and storage registers.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial Power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The shift register has a serial input (DS) and a serial output (Q7S) for cascading purposes. Data is shifted on the positive-going transitions of the SHCP input. The data in the shift register is transferred to the storage register on a positive-going transition of the STCP input. If both clocks are connected together, the shift register will always be one clock <u>pulse</u> ahead of the storage register. A LOW level on one of the two register reset pins (SHR and STR) will clear the corresponding register.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Balanced propagation delays
- All inputs have Schmitt-trigger action
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Applications

- Serial-to-parallel data conversion
- Remote control holding register



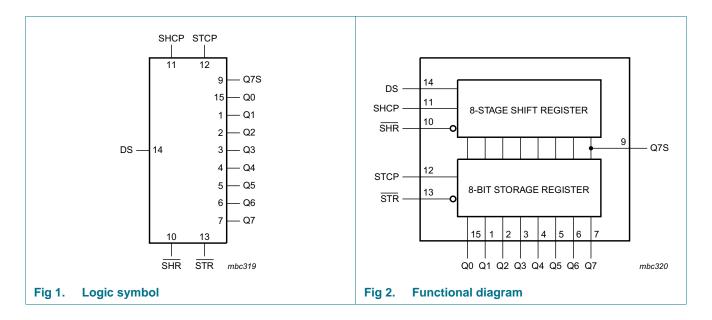
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4. Ordering information

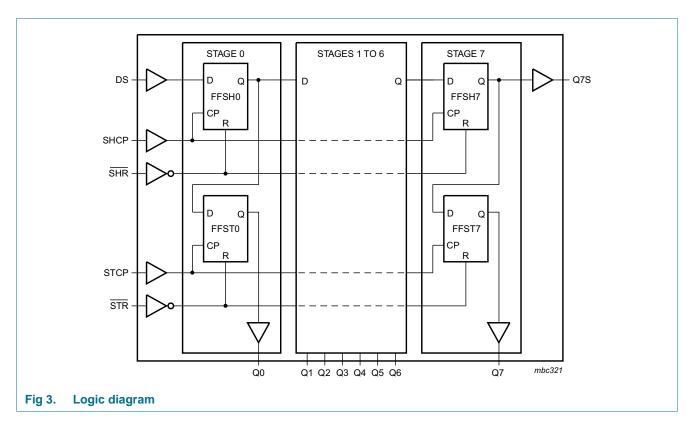
Table 1. Ordering information

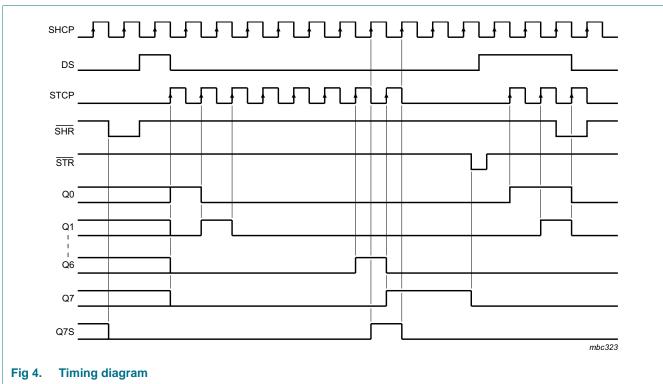
Type number	Package	Package							
	Temperature range	Name	Description	Version					
74LVC594AD	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74LVC594APW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					
74LVC594ABQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1					

5. Functional diagram



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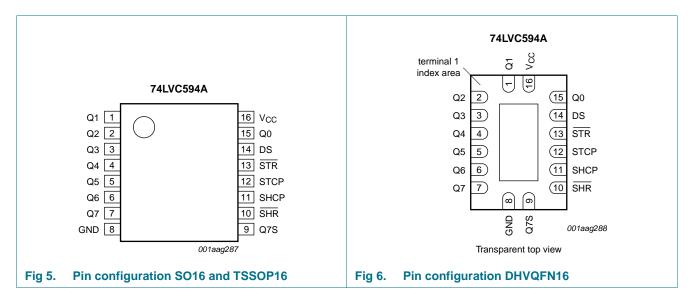




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6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	15, 1, 2, 3, 4, 5, 6, 7	parallel data output
GND	8	ground (0 V)
Q7S	9	serial data output
SHR	10	shift register reset (active LOW)
SHCP	11	shift register clock input
STCP	12	storage register clock input
STR	13	storage register reset (active LOW)
DS	14	serial data input
V _{CC}	16	supply voltage

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7. Functional description

Table 3. Function table[1]

Input					Outpu	t	Function
SHCP	STCP	SHR	STR	DS	Q7S	Qn	
Χ	Χ	L	Χ	Χ	L	NC	a LOW-state on SHR only affects the shift register
Χ	Χ	Χ	L	Χ	NC	L	a LOW-state on STR only affects the storage register
Χ	↑	L	Н	Χ	L	L	empty shift register loaded into storage register
↑	X	Н	X	Н	Q6S	NC	logic HIGH level shifted into shift register stage 0. Contents of all shift register stages shifted through, e.g. previous state of stage 6 (internal Q6S) appears on the serial output (Q7S).
X	\uparrow	Н	Н	Χ	NC	QnS	contents of shift register stages (internal QnS) are transferred to the storage register and parallel output stages
↑	1	Н	Н	Х	Q6S	QnS	contents of shift register shifted through; previous contents of the shift register is transferred to the storage register and the parallel output stages

^[1] H = HIGH voltage state;

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I_{IK}	input clamping current	$V_{l} < 0 V$	-50	-	mA
V_{I}	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 \text{ V}$	-	±50	mA
V_{O}	output voltage	3-state	<u>[1]</u> –0.5	6.5	V
		output HIGH or LOW state	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
I _O	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[2] _	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

L = LOW voltage state;

^{↑ =} LOW-to-HIGH transition;

X = don't care;

NC = no change;

^[2] For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For TSSOP16 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN16 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

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9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V_{I}	input voltage		0	-	5.5	V
Vo	output voltage	3-state	0	-	5.5	V
		output HIGH or LOW state	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
		V _{CC} = 2.7 V to 3.6 V	-	-	10	ns/V

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V_{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} – 0.2	-	-	$V_{CC}-0.3$	-	V
		$I_O = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
II	input leakage current	V_{CC} = 3.6 V; V_I = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

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 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	°C	-40 °C to	–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}$; $V_I \text{ or } V_O = 5.5 \text{ V}$	-	0.1	10	-	20	μΑ	
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μА	
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$	-	5	500	-	5000	μА	
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF	

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +85	5 °C	-40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	SHCP to Q7S; see Figure 7	[2]			•	•	•	
	V _{CC} = 1.2 V		-	17.5	-	-	-	ns	
	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.0	5.2	15.8	2.0	18.2	ns	
	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.2	8.1	1.5	9.3	ns	
		$V_{CC} = 2.7 \text{ V}$		1.5	3.5	7.6	1.5	8.7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.1	6.7	1.5	7.7	ns
		STCP to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	19.3	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.0	7.6	15.8	2.0	18.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	4.8	8.1	1.5	9.3	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	5.2	7.6	1.5	8.7	ns
	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.2	4.5	6.7	1.2	7.7	ns	

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Table 7. Dynamic characteristics ...continued Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 13</u>.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t _{PHL}	HIGH to LOW	SHR to Q7S; see Figure 11	'					
	propagation delay	V _{CC} = 1.2 V	-	12.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.0	5.0	15.8	2.0	18.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.5	3.8	8.1	1.5	9.3	ns
		$V_{CC} = 2.7 \text{ V}$	1.2	3.9	7.6	1.2	8.7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.2	3.3	6.7	1.2	7.7	ns
		STR to Qn; see Figure 12						
		V _{CC} = 1.2 V	-	20.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.0	7.7	15.8	2.0	18.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.5	5.0	8.1	1.5	9.3	ns
		$V_{CC} = 2.7 \text{ V}$	1.2	5.3	7.6	1.2	8.7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.2	4.4	6.7	1.2	7.7	ns
t_{W}	pulse width	SHCP, STCP HIGH or LOW; see Figure 7 and Figure 8						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	6.0	2.5	-	7.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	5.0	2.0	-	5.5	-	ns
		$V_{CC} = 2.7 \text{ V}$	4.5	1.5	-	5.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	4.0	1.5	-	4.5	-	ns
		SHR, STR LOW; see Figure 11 and Figure 12						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	6.0	2.5	-	5.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	4.0	2.0	-	4.5	-	ns
		$V_{CC} = 2.7 \text{ V}$	2.5	1.5	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.5	1.5	-	3.0	-	ns
t _{su}	set-up time	DS to SHCP; see Figure 9						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	5.0	1.0	-	5.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	4.0	0.8	-	4.5	-	ns
		$V_{CC} = 2.7 \text{ V}$	2.0	0.6	-	2.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	0.6	-	2.5	-	ns
		SHR to STCP; see Figure 10						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	8.0	3.5	-	8.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	5.0	2.1	-	5.5	-	ns
		V _{CC} = 2.7 V	4.0	1.8	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	4.0	1.7	-	4.5	-	ns
		SHCP to STCP; see Figure 8						
		V _{CC} = 1.65 V to 1.95 V	8.0	3.5	-	8.5	-	ns
		V _{CC} = 2.3 V to 2.7 V	5.0	2.1	-	5.5	-	ns
		V _{CC} = 2.7 V	4.0	1.8	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	4.0	1.7	-	4.5	-	ns

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 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t _h	hold time	DS to SHCP; see Figure 9	·		•		•		
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	0.2	-	2.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	0.1	-	2.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	-0.1	-	2.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	-0.2	-	1.5	-	ns
t _{rec}	recovery time	SHR to SHCP, STR to STCP; see Figure 11 and Figure 12							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		5.0	-2.7	-	5.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		4.0	-1.5	-	4.5	-	ns
		$V_{CC} = 2.7 \text{ V}$		2.0	-1.0	-	2.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.0	-1.0	-	2.5	-	ns
f _{max}	maximum frequency	SHCP or STCP; see Figure 7 and Figure 8							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		80	130	-	70	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		100	140	-	90	-	MHz
		$V_{CC} = 2.7 \text{ V}$		110	150	-	100	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		130	180	-	115	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C_{PD}	power dissipation	$V_I = GND$ to V_{CC}	[4]						
	capacitance	V_{CC} = 1.65 V to 1.95 V		-	50	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	45	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	44	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

$$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \sum (C_L \times V_{CC}{}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

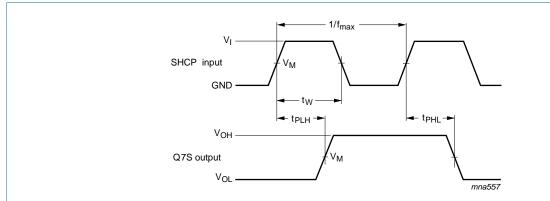
^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

^[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

^[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

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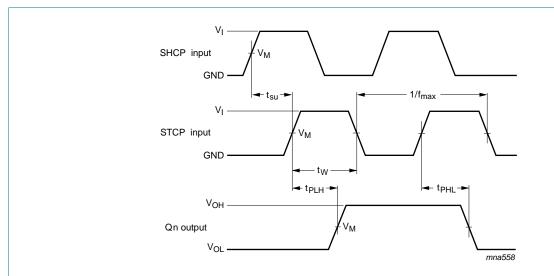
12. Waveforms



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

Fig 7. The shift clock (SHCP) to serial data output (Q7S) propagation delays, the shift clock pulse width and maximum shift clock frequency

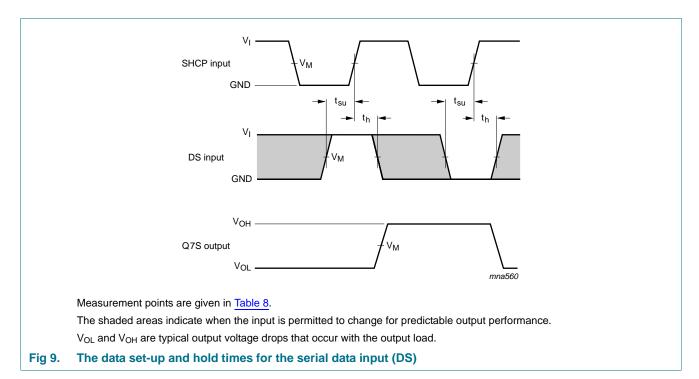


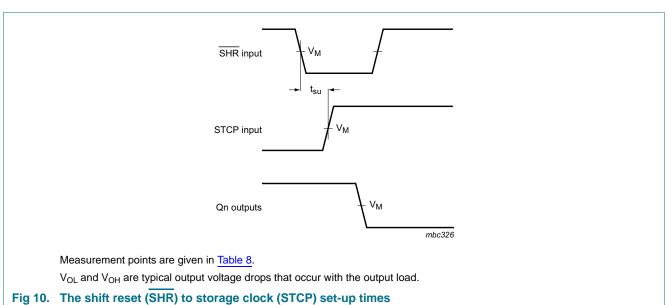
Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

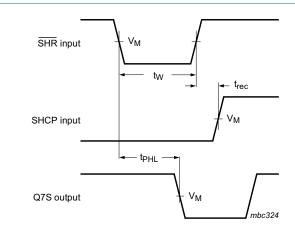
Fig 8. The storage clock (STCP) to parallel data output (Qn) propagation delays, the storage clock pulse width and the shift clock to storage clock set-up time

8-bit shift register with output register





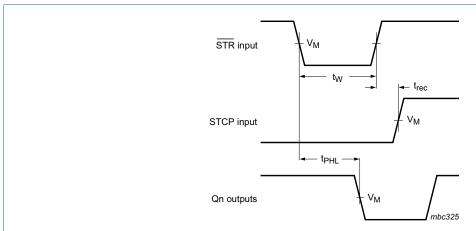
8-bit shift register with output register



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

Fig 11. The shift reset (SHR) pulse width, the shift reset to serial data output (Q7S) propagation delays and the shift reset to shift clock (SHCP) recovery time



Measurement points are given in Table 8.

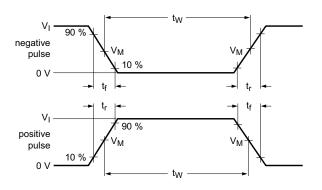
 V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

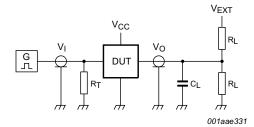
Fig 12. The storage reset (STR) pulse width, the storage reset to parallel data output (Qn) propagation delays and the storage reset to storage clock (STCP) recovery time

Table 8. Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _M
V _{CC} < 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
$V_{CC} \ge 2.7 \text{ V}$	1.5 V	1.5 V

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Test data is given in Table 9. Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 13. Test circuit for measuring switching times

Table 9. Test data

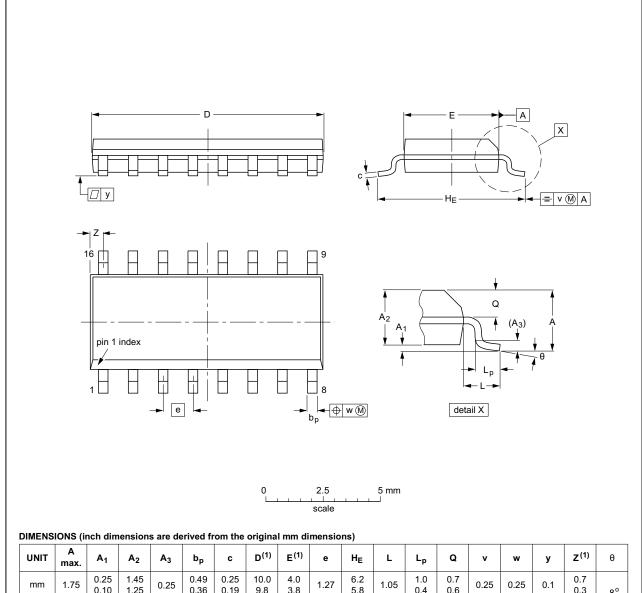
Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t_{PLZ}, t_{PZL}	t_{PHZ} , t_{PZH}	
1.2 V	V_{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V_{CC}	\leq 2 ns	30 pF	1 k Ω	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V_{CC}	\leq 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND	

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13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UN	IIT	A max.	A ₁	A ₂	A ₃	b _p	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	У	Z ⁽¹⁾	θ
mı	m	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inch	nes	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	IEC JEDEC				JEITA
SOT109-1	076E07	MS-012				99-12-27 03-02-19

Fig 14. Package outline SOT109-1 (SO16)

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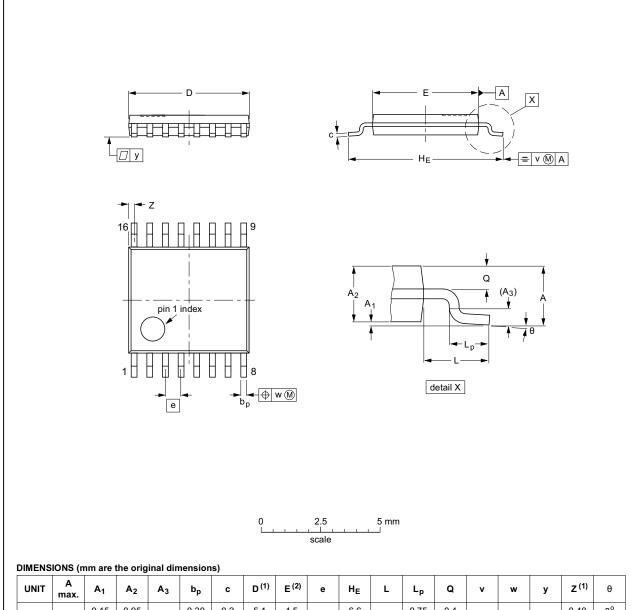
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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UN	IIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mı	m	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE		
SOT403-1		MO-153				-99-12-27 03-02-18		

Fig 15. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

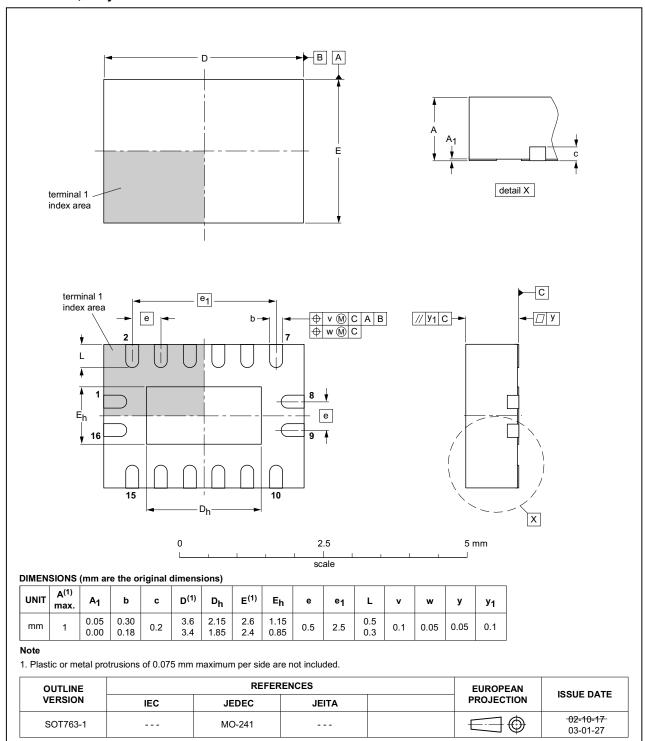


Fig 16. Package outline SOT763-1 (DHVQFN16)

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14. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 11. Revision history

Release date	Data sheet status	Change notice	Supersedes
20131021	Product data sheet	-	74LVC594A v.1
		n redesigned to comply v	vith the new identity
 Legal texts 	have been adapted to the	new company name whe	ere appropriate.
20070524	Product data sheet	-	-
	20131021 The format guidelines of Legal texts	 20131021 Product data sheet The format of this data sheet has beer guidelines of NXP Semiconductors. Legal texts have been adapted to the 	Product data sheet The format of this data sheet has been redesigned to comply we guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name wheelegal texts have been adapted.

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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